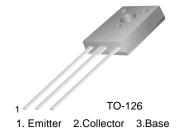


## BD176/178/180

# Medium Power Linear and Switching Applications

• Complement to BD 175/177/179 respectively



# **PNP Epitaxial Silicon Transistor**

### Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

Symbol	Paramo	eter	Value	Units
$V_{CBO}$	*Collector-Base Voltage	: BD176	- 45	V
020		: BD178	- 60	V
		: BD180	- 80	V
V <sub>CEO</sub>	Collector-Emitter Voltage	: BD176	- 45	V
		: BD178	- 60	V
		: BD180	- 80	V
V <sub>EBO</sub>	Emitter-Base Voltage		- 5	V
I <sub>C</sub>	Collector Current (DC)		- 3	А
I <sub>C</sub>	*Collector Current (Pulse)		- 7	А
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> =25°C)		30	W
$R_{\theta ja}$	Junction to Ambient		70	°C/W
R <sub>θjc</sub>	Junction to Case		8.5	°C/W
T <sub>J</sub>	Junction Temperature		150	°C
T <sub>STG</sub>	Storage Temperature		- 65 ~ 150	°C

### Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V <sub>CEO</sub> (sus)	* Collector-Emitter Sustaining Voltage					
	: BD176	$I_C = -100 \text{mA}, I_B = 0$	- 45			V
	: BD178		- 60			V
	: BD180		- 80			V
I <sub>CBO</sub>	Collector Cut-off Current : BD176	$V_{CB} = -45V, I_{E} = 0$			- 100	μΑ
	: BD178	$V_{CB} = -60V, I_{E} = 0$			- 100	μΑ
	: BD180	$V_{CB} = -80V, I_{E} = 0$			- 100	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	V <sub>EB</sub> = - 5V, I <sub>C</sub> = 0			- 1	mA
h <sub>FF1</sub>	* DC Current Gain	V <sub>CE</sub> = - 2V, I <sub>C</sub> = - 150mA	40		250	
h <sub>FE2</sub>		$V_{CE} = -2V, I_{C} = -1A$	15			
V <sub>CE</sub> (sat)	* Collector-Emitter Saturation Voltage	I <sub>C</sub> = -1 A , I <sub>B</sub> = - 0.1A			- 0.8	V
V <sub>BE</sub> (on)	* Base-Emitter On Voltage	V <sub>CE</sub> = - 2V, I <sub>C</sub> = -1 A			- 1.3	V
f <sub>T</sub>	Current Gain Bandwidth Product	$V_{CE} = -10V, I_{C} = -250mA$	3			MHz

<sup>\*</sup> Pulse Test: PW=300µs, duty Cycle=1.5% Pulsed

### **h**<sub>FE</sub> Classificntion

Classification	6	10	16	
h <sub>FE1</sub>	40 ~ 100	63 ~ 160	100 ~ 250	
* Classification 16: Only BD 176				

# **Typical Characteristics**

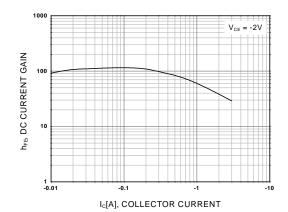


Figure 1. DC current Gain

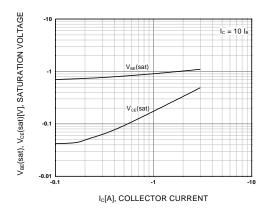


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

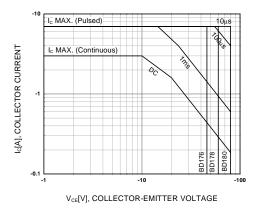


Figure 3. Safe Operating Area

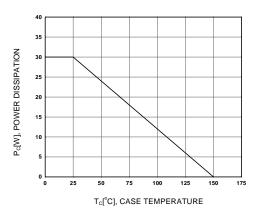
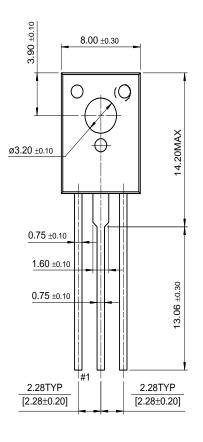
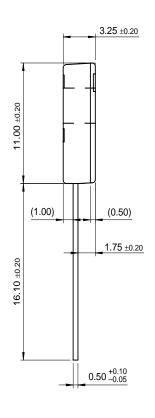


Figure 4. Power Derating

BD176/178/180

# TO-126





Dimensions in Millimeters

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EnSigna™	$I^2C^{TM}$	$OCX^{TM}$	RapidConfigure™	UHC™
Across the board.	. Around the world.™	OCXPro™	RapidConnect™	UltraFET <sup>®</sup>
The Power Franc	hise™	OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	$VCX^{TM}$
Programmable Ad	ctive Droop™	OPTOPLANAR™	SMART START™	

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